## N-Channel 30-V (D-S) MOSFET

### **Key Features:**

- Low r<sub>DS(on)</sub> trench technology
- · Low thermal impedance
- Fast switching speed

### **Typical Applications:**

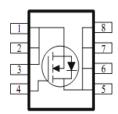
- DC/DC Conversion
- Power Routing
- Motor Drives

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}(m\Omega)$	I <sub>D</sub> (A)		
30	1.9 @ V <sub>GS</sub> = 10V	112 <sup>c</sup>		
30	$2.4 @ V_{GS} = 4.5V$	112		









ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}$ C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Limit	Units			
Drain-Source Voltage			30	V		
Gate-Source Voltage	$V_{GS}$	±20	V			
	T <sub>A</sub> =25°C		42 <sup>a</sup>	A		
Continuous Drain Current	T <sub>A</sub> =70°C	l L	34 <sup>a</sup>			
Continuous Diam Guitent	T <sub>C</sub> =25°C	l <sub>D</sub>	112 <sup>c</sup>			
	T <sub>C</sub> =70°C		112 <sup>c</sup>			
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	150				
Continuous Source Current (Diode Conduction) a	I <sub>S</sub>	7.2				
	T <sub>A</sub> =25°C		5 <sup>a</sup>	W		
Power Dissipation	T <sub>A</sub> =70°C	P <sub>D</sub>	3.2 <sup>a</sup>			
Prower Dissipation	T <sub>C</sub> =25°C		83			
	T <sub>C</sub> =70°C		53			
Operating Junction and Storage Temperature Range	$T_J$ , $T_{stg}$	-55 to 150	°C			

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Maximum	Units				
Maximum Junction-to-Ambient <sup>a</sup>	t <= 10 sec	D	25	°C/W			
IMAXIIIUIII JUIICIIOII-IO-AIIIDIEIII	Steady State	$R_{\theta JA}$	65				
Maximum Junction-to-Case (Drain)	Steady State	$R_{\theta JC}$	1.5				

#### Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature
- c. Package limited

### **Electrical Characteristics**

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit		
Static								
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \text{ uA}$	1			V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA		
Zero Gate Voltage Drain Current	lana	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$		1	uA			
Zero Gate Voltage Brain Gurrent	I <sub>DSS</sub>	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$	10	10				
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	60			Α		
Drain Source On Besistance a	r	$V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$			1.9 mC			
Drain-Source On-Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 16 \text{ A}$			2.4	11152		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$		11		S		
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 3.6 \text{ A}, V_{GS} = 0 \text{ V}$		0.7		V		
		Dynamic <sup>b</sup>						
Total Gate Charge	$Q_g$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V},$		55				
Gate-Source Charge	$Q_{gs}$	$I_{D} = 20 \text{ A}$		15		nC		
Gate-Drain Charge	$Q_gd$	1D = 20 A		19				
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DS} = 15 \text{ V}, R_1 = 0.8 \Omega,$		15				
Rise Time	t <sub>r</sub>	$I_{DS} = 13 \text{ V}, K_L - 0.6 \Omega,$ $I_D = 20 \text{ A},$		21		no		
Turn-Off Delay Time	$t_{d(off)}$	$V_{GEN} = 10 \text{ V}, R_{GEN} = 6 \Omega$		167		ns		
Fall Time	t <sub>f</sub>	V GEN = 10 V, 1 (GEN = 0.12		74				
Input Capacitance	C <sub>iss</sub>			5770				
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ Mhz}$		1003		pF		
Reverse Transfer Capacitance	$C_{rss}$			655				

#### **Notes**

- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

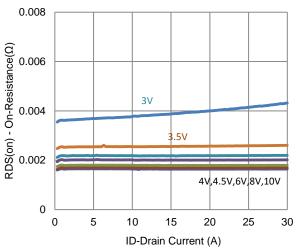
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### **Typical Electrical Characteristics**

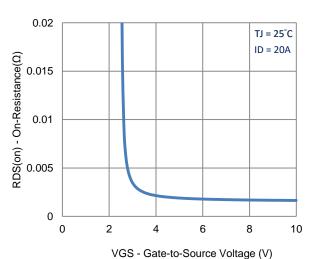
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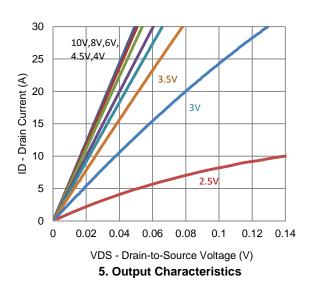
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#### 1. On-Resistance vs. Drain Current



3. On-Resistance vs. Gate-to-Source Voltage



30 TJ = 25°C (¥) 20 Orden 10 Orden 10

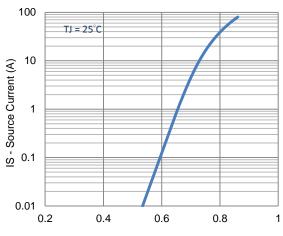
VGS - Gate-to-Source Voltage (V)

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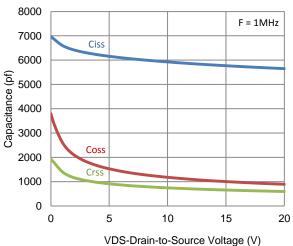


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VSD - Source-to-Drain Voltage (V)

#### 4. Drain-to-Source Forward Voltage

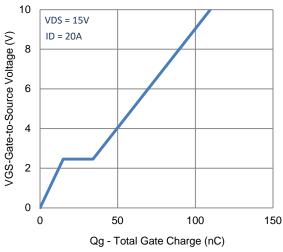


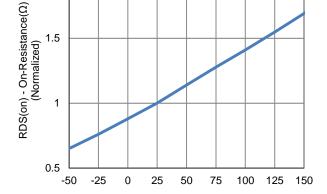
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6. Capacitance

### **Typical Electrical Characteristics**

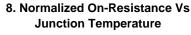
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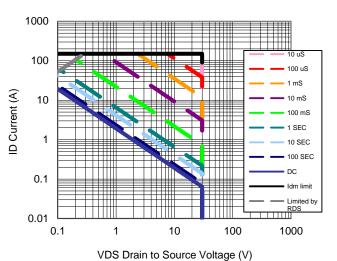


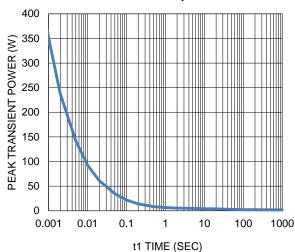


TJ -JunctionTemperature(°C)



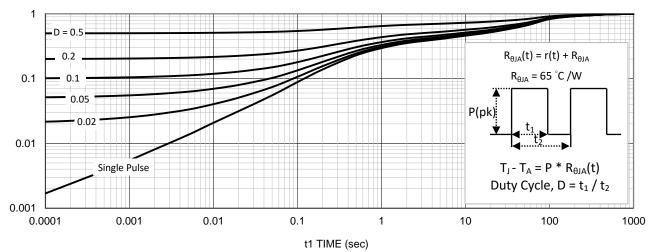






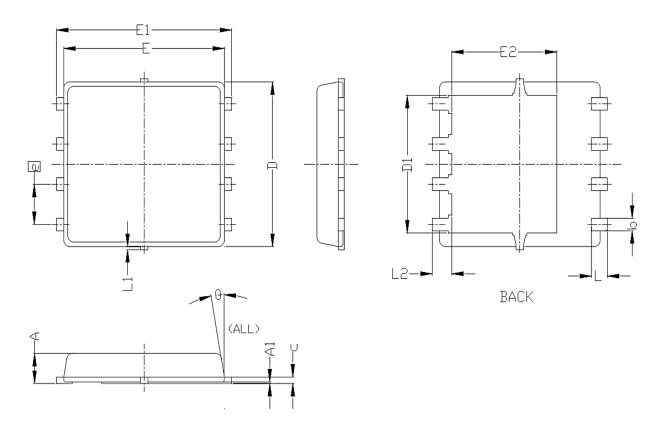
### 9. Safe Operating Area

10. Single Pulse Maximum Power Dissipation



11. Normalized Thermal Transient Junction to Ambient

# Package Information



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES			
STMBULS	MIN	NOM	MAX	MIN	NOM	MAX	
A	0.85	0.95	1.00	0.033	0.037	0.039	
A1	0.00		0.05	0.000		0.002	
b	0.30	0.40	0.50	0.012	0.016	0.020	
с	0. 15	0. 20	0.25	0.006	0.008	0.010	
D	5, 20 BSC			0. 205 BSC			
D1	4. 35 BSC			0. 171 BSC			
Е	5, 55 BSC 0, 219 BSC						
E1	6. 05 BSC			0. 238 BSC			
E2		3. 62 BSC 0. 143 BSC					
e	1. 27 BSC			0.050 BSC			
L	0.45	0.55	0.65	0.018	0.022	0.026	
L1	0		0.15	0		0.006	
L2		0. 68 REF 0. 027 REF					
θ	0°		10°	0°		10°	

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